Universal 8-pin CAN Evaluation Module



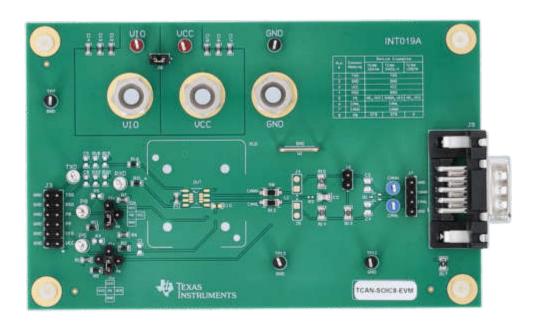
Description

The universal 8-pin CAN EVM provides users with the ability to evaluate all of Tl's 8-pin CAN transceiver families. The universal 8-pin CAN EVM is configurable for use with all Tl 8-pin CAN transceiver families by populating the transceiver and setting jumpers on the EVM.

This EVM also has the footprints for a SIC network, to the CAN bus lines via user-installed J4 and J5. Connecting the SIC network to CANH and CANL simulates a noisy CAN bus by adding more reflections and ringing to the signals. This can be used to test the reliability of the transceiver in a very noisy environment.

Features

- Standard and split termination on the CAN bus
- Footprints for filter capacitors, common-mode choke, and TVS diode for CAN bus protection from RF noise and transient pulses
- Footprints for common 8-pin SOIC socket, and CAN FD SIC loading
- DSUB9 connector with the CAN bus signals and GND for typical automotive cable harness connections
- All digital signals for configuration and control brought out to a header for easy access
- Multifunctional jumpers for different functional use of generic pins



TCAN-SOIC8-EVM

1 Evaluation Module Overview

1.1 Introduction

This user's guide details the universal 8-pin CAN (Controller Area Network) EVM operation. All of the options and the overall operation of the EVM are explained in this user's guide. This user's guide explains the EVM configurations for basic CAN evaluation, various load and termination settings.

1.2 Kit Contents

Universal 8-pin CAN EVM

1.3 Specification

TI offers a broad portfolio of high speed (HS) CAN, CAN FD, and CAN SIC transceivers. These include 5V V_{CC} only, 3.3V V_{CC} only, and 5V V_{CC} with I/O level shifting CAN transceivers. These CAN transceiver families include product mixes with varying features such as low-power standby modes with and without wake up, silent modes, loop back, and diagnostic modes.

TI's CAN EVM helps designers evaluate the operation and performance of various TI CAN transceivers in normal and SIC networks. CAN EVM also provides bus termination, bus filtering, and protection concepts. CAN EVM is easily configured by the user for the TI 8-pin CAN transceiver families as needed by jumper settings, simple soldering tasks, and replacement of standard components. A separate EVM is available for the galvanic-isolated CAN transceiver family.

1.4 Device Information

The CAN EVM has simple connections to all necessary pins of the CAN transceiver device, and jumpers where necessary to provide flexibility for device pin and CAN bus configuration. There are test points (loops) for all main points where probing is necessary for evaluation such as GND, V_{CC} , TXD, RXD, CANH, CANL, pin 8 (mode pin), or pin 5 (various functions). The EVM supports many options for CAN bus configuration. The CAN EVM allows for two termination schemes through a single jumper to select between just split termination configuration, or split with 120Ω resistor as well. If needed, there are footprints for a common-mode choke, TVS diode for ESD protection, and capacitors for further EMC protection, or signal conditioning. A DSUB9 connector is included to allow the evaluation and use of the CAN bus in larger systems.

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Jumper Information

Table 2-1 lists the jumper connections for the EVM.

Table 2-1. Jumper Connections

Connection	Туре	Description
		Functional use of generic pin 5. Options for use are:
J1A, J1B, J1C	4-way jumper	 J1A1: V_{IO} for transceiver with digital I/O voltage input on pin 5. Populate C10 or C18 if pin 5 used as V_{IO}. Provides customer installable pulldown R4 to GND, and 0-Ohm pullup placeholder R2 J1A3: 0Ω pulldown to GND for transceiver with digital input on pin 5 J1B: Active split termination for CAN transceiver with V_{REF} or SPLIT on pin 5. Short J1A2 – J1B and populate R3 for split termination as required J1C: 4.7kΩ pullup to V_{CC} for transceiver with digital input on pin 5, or external pullup for open drain output on pin 5
J2A, J2B	3-way jumper	 Used for mode selection or polarity configuration. Options for use are: J2A1: 4.7kΩ pullup to V_{IO} for transceivers with digital input on pin 5. Provides customer installable pulldown for devices with slew rate control R_S pin J2A3: 0Ω pulldown to GND for transceiver with digital input on pin 5 J2B: 4.7kΩ pullup to V_{CC} for transceivers with digital input on pin 5
J3	12-pin header	Connection for access to all critical digital I/O, supply, and GND for driving the CAN transceiver externally with test equipment or interfaced to a processor EVM
J4	2-pin jumper	Connect SIC network to CANH. Must be used in combination with J5
J5	2-pin header	Connect SIC network to CANL. Must be used in combination with J4
J6	2-pin jumper	Connect R13, a 120Ω CAN termination to the bus. Along with the already populated 120 ohms (R10 and R14 in series), this simulates the true CAN bus impedance of 60 ohms (two 120 ohm terminating resistors in parallel). Shunting J6 places R13 on the bus, not placing a shunt opens the bus and only leaves R10 and R14 for the termination.
J7	4-pin header	CAN bus connection (CANH, CANL) and GND
J8	2-pin jumper	V_{IO} and V_{CC} supply connection. Provides ability to short V_{CC} and V_{IO} together
J9	DSUB9 Connector	Provides an optional way to connect CANH, CANL, and GND all through a standard DB9 CAN pinout rather than through a regular header.
W1	Ground clip	Provides extra connection to GND
TP1		Device generic pin 5 test point
TP2		CANH (bus) test point
TP3		Device generic pin 8 test point
TP4		CANL (bus) test point
TP5	Test point	TXD, Device pin 1 test point
TP6	ισοι μοιπι	RXD, Device pin 4 test point
TP7, TP8, TP11, TP12		GND test points
TP9		V _{IO} test point
TP10		V _{CC} test point

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2.1 EVM Setup and Operation

This section describes the setup and operation of the EVM for parameter performance evaluation.

2.1.1 Overview and Basic Operation Settings

2.1.1.1 V_{CC} Power Supply (J3, P2, TP10)

The basic setup of the CAN EVM uses a single power supply required to evaluate standard 5V or 3.3V single-supply transceiver device performance. For single-supply transceivers, connect the 5V or 3.3V V_{CC} supply to the P2 banana jack, or the V_{CC} and GND test-point loops. The power supplied must meet the required specification of V_{CC} for the transceiver being tested.

2.1.1.2 I/O Power Supply V_{IO} or V_{RXD} (J3, J8, P1,or TP9)

For devices with I/O level shifting, a second supply pin for the I/O or RXD pin is on pin 5 of the transceiver device. A second power supply is needed to test one of these devices. Power can be supplied to this pin by either shunting V_{CC} and V_{IO} together via J8, or connecting a separate power supply via J3, P1 banana jack, or TP8. Install a local buffering and decoupling capacitor at C10 if the EVM is used for one of these devices.

2.1.1.3 Main Supply and I/O Header (J3)

All key I/O and supply GND functions are brought to this header. This header can be used on either interface to test equipment or a short cable can be made to connect to an existing customer-application board with a CAN controller.

Pin	Connection	Description
1	V _{CC}	Pin 3 of transceiver, V _{CC}
3	V _{IO}	Supports level-shifting functions of devices with V _{IO} or V _{RXD} pin
5	P5	Generic pin 5 of transceiver, various functions depending on transceiver, examples: V_{REF} , SPLIT, V_{RXD} , V_{IO} , LBK, EN, AB, SHDN, FAULT and No Connect (NC)
7	P8	Generic pin 8 of transceiver, normally used for mode control, examples: R _S , SW, S, STB and No Connect (NC)
9	RXD	Pin 4 of transceiver, RXD (receive data)
11	TXD	Pin 1 of transceiver, TXD (transmit data)
2		
4		
6	CND	Din 2 of transactiver, CND
8	GND	Pin 2 of transceiver, GND
10	1	
12		

Table 2-2. J3 Pin Definitions

This header is arranged to provide a separate ground for each signal pair (TXD/GND and RXD/GND). If the EVM is being used with lab equipment, connect separate cables to these main points via simple 2-pin header connectors. If connecting the board to a processor-based system, connect a single cable with all power and signals via a 12-pin header cable to this port.

2.1.1.4 TXD Input (J3 or TP5)

The TXD (pin 1) of the transceiver, transmit data, is routed to J3 and TP5. The signal path to the J3 header is pre-installed with a 0Ω series resistor, R16. An optional pullup resistor to VIO can be installed on R15, an optional pulldown resistor to GND can be installed on R18, and an optional filtering capacitor can be installed on C5.

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2.1.1.5 RXD Output (J3 or TP6)

The RXD (pin 4) of the transceiver, receive data, is routed to J3 and TP6. The signal path to the J3 header is pre-installed with a 0Ω series resistor, R21. An optional pullup resistor to VIO can be installed on R20, an optional pulldown resistor to GND can be installed on R22, and an optional filtering capacitor can be installed on C9.

2.1.1.6 Generic Pin 8 (J2, J3, or TP3)

Pin 8 of the transceiver is normally a mode control or polarity switch pin of the device. Pin 8 of the device is routed to J2, J3, and TP3.

2.1.1.7 Pin 8 - J2 Configurations (3-Way Jumper)

If using separate I/O inputs, then J2 is used to configure pin 8 to: pullup to V_{IO} , pullup to V_{CC} or pulldown to GND. This pin can be pulled up to V_{IO} by connecting a shunt to the J2A1 and J2A2 pins on J2, pulled up to V_{CC} by connecting a shunt to the J2A2 and J2B pins, or pulled down to GND by connecting a shunt to the J2A2 and J2A3 pins on J1.

- Mode Control input (S, STB, R_S): if the device and application use pin 8 as mode control, set J2 to
 pulldown to GND for a normal or high-speed mode, (R11 is pre-installed with 0Ω resistor to GND for this
 purpose) or pullup to V_{CC}/V_{IO} for a silent or low-power standby mode.
- Slope Control (R_S): if the device and application use pin 8 as slope control, use the resistance to ground value to determine the slope of the driver output. R9 is left open for customers who want to install a resistance to ground and use slope mode.
- **Polarity Configuration (SW)**: if the device and application use pin 8 as polarity configuration, set J2 to pulldown to GND for normal polarity, or pullup to V_{IO} for reverse polarity.
- No Connection (NC): If the device and application require no use of pin 5, then leave open or pulled to GND.

2.1.1.8 TP3 Configuration

This connects directly to device pin 8. Make sure J2 configuration is not conflicting if TP3 is used as the input connection.

2.1.1.9 Generic Pin 5 (J1, J3 or TP1)

Pin 5 of the transceiver has various uses depending on the transceiver. Pin 5 of the device is routed to J1, J3 and TP1.

2.1.1.10 Pin 5 - J1 Configurations (4-Way Jumper)

If using separate I/O inputs, J2 is used to configure pin 8 to: pullup to V_{IO} supply input, pullup to V_{CC} , pulldown to GND, or V_{REF} or SPLIT termination output. This pin can be pulled up to V_{IO} by connecting a shunt to the J1A2 and J1A1 pins on J2, pulled up to V_{CC} by connecting a shunt to the J1A2 and J1C pins, pulled down to GND by connecting a shunt to the J1A2 and J1A3 pins on J1, or SPLIT termination output by connecting a shunt to the J1A2 and J1B pins.

- V_{REF} or SPLIT termination (V_{CM}): If the device and application support split termination, set J1 to V_{CM} (V common mode) to drive the V_{REF} or SPLIT pin common mode stabilizing voltage output to the center tap of the split termination capacitor.
- No Connection (NC): If the device and application require no use of pin 5, leave open. If the device has the
 V_{REF} or SPLIT pin, but the application is not using the pin for split termination, then add a capacitor on C1 to
 improve EMC performance.
- 2nd Mode or Control Input (LBK, EN, AB, SHDN): If the device and application use pin 5 as a second
 mode or control pin, then set J1 as either a pullup to V_{CC} or pulldown to GND, as necessary. R4 is left open
 for customers who want to install a resistance to ground.
- I/O and RXD level-shifting supply: If the device and application used with V_{IO} or V_{RXD} to level shift I/O pins on the transceiver, then set J1 to V_{IO} connecting pin 5 of the device to the V_{IO} supply input. Install local buffering and bypass capacitor C10 (no socket) or C18 (has socket).
- Open Drain Output (FAULT): If the device and application use pin 5 as an open drain output, then external
 pullup is required. Set J1 as either a pullup to V_{CC} or V_{IO}.

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2.1.1.11 TP1 Configuration

This connects directly to device pin 5. Make sure J1 configuration is not conflicting if P5 is used as an input connection.

2.1.1.12 J8 Configuration

If using a device that supports I/O level shifting with a V_{IO} pin on pin 5, this jumper can be used to provide power to pin 5. A shunt can be placed between pins 1 and 2 of J8 to short V_{CC} and V_{IO} together and allow V_{CC} to power V_{IO} .

2.1.1.13 SIC Network Configuration (J4 & J5)

The SIC network can be enabled connecting shunts to J4 and J5. This connects the network of inductors, capacitors, and resistors to the CANH and CANL lines and create a much noisier CAN bus. Note that both J4 and J5 need to be shunted for this to work. All SIC network components are left open and need user installation.

2.1.2 Using CAN Bus Load, Termination, and Protection Configurations

The generic 8-pin CAN EVM is populated with one 120Ω resistor selectable via jumper, between CANH and CANL, and the 120Ω split termination (two 60Ω resistors in series) including the split capacitor. When using only split termination, the EVM is used as a terminated end of a bus. For electrical measurements to represent the total loading of the bus, use both the split termination and the 120Ω resistor in parallel to give the standard 60Ω load for parametric measurement. Table 2-3 summarizes how to use these termination options.

Table 2-3. Bus Termination Configuration

Termination Configuration	120Ω Resistor	Split Termination Resistors		Split Termination Capacitor	
	J6	R10	R14	C3	
60Ω load - electrical parameterics	shorted	60Ω 60Ω		populated	
Split termination (common mode stabilization)	open	0012	0012	populated	

The EVM also has footprints for various protection schemes to enhance robustness for extreme system-level EMC requirements. Table 2-4 summarizes these options.

Table 2-4. Protection and Filtering Configuration

Configuration	Footprint Reference	Use Case	Population and Description
		Direct CAN transceiver to bus connection	
Series resistors or common mode choke	R8/R12 or L1 (common footprint)	Series resistance protection, CAN transceiver to bus connection	R8 and R12 populated with MELF resistor as necessary for harsh EMC environment
		CM choke (bus filter)	L1 populated with CM choke to filter noise as necessary for harsh EMC environment
Bus filtering caps transient	C2/C4	Bus filter	Filter noise as necessary for harsh EMC environment. Use filter caps in combination with L1 CM choke
protection	D1	Transient and ESD protection	To add extra protection for system level transients and ESD protection, D1 populated with ESD2CAN24-Q1

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2.1.3 Using Customer Installable I/O Options for Current Limiting, Pullup and Pulldown, Noise Filtering

The generic 8-pin CAN EVM has footprints on the PCB for the installation of various filtering and protection options to adapt the EVM to match CAN network topology requirements if the EVM is being used as a CAN node.

Each digital input or output pin has footprints allowing for series current-limiting resistors (default populated with 0Ω), pullup or down resistors (depending on pin use), and a capacitor to GND which allows for RC filters when configured with a series resistor. Table 2-5 lists these features for each of the digital input and output pins of the EVM. Replace or populate the RC components as necessary for the application.

Table 2-5. RC Filter and Protection Lists

	Table 2-3. IXO I liter and I Totection Lists									
	Device Pi	n	Jumper			Pullup and	C to GND	Description		
No.	Description	Туре	Pullup	Pulldown	Jenes IX	Pulldown	CIOGIAD	Bescription		
1	TXD	Input	N/A	N/A	R16	R15 PU/ R18 PD	C5			
4	RXD	Output	N/A	N/A	R21	R20 PU/ R22 PD	C9			
	NC	No Connect	N/A	N/A	N/A	N/A	N/A			
	SHDN, AB, EN, and LBK	Input	R1/R2 (J1)	R4/R5 (J1)	N/A	N/A	C1			
	FAULT	Output	R1/R2(J1)	R4/R5 (J1)	N/A	N/A	C1			
5	V _{REF} and SPLIT	Output	N/A	N/A	N/A	N/A	C1/C3	Split termination: J1 to route output to split termination center point capacitor C3. EMC for systems not using split termination: C1 to GND.		
	V_{IO} and V_{RXD}	Supply Input	N/A	N/A	N/A	R2 PU/ R4 PD	C1/C10/C1 8	Use J3, J8, P1 and TP9 as necessary to provide supply input.		
8	SW, R _S , S, STB	Input	R6/R7 (J2)	R9/R11 (J2)	N/A	N/A	N/A	R9 pulldown to GND (J2) user- installable for use with slope mode on devices with R _S pin.		
	NC	No Connect	N/A	N/A	N/A	N/A	N/A			



3 Hardware Design Files

3.1 Schematics

Figure 3-1 shows the EVM schematic.

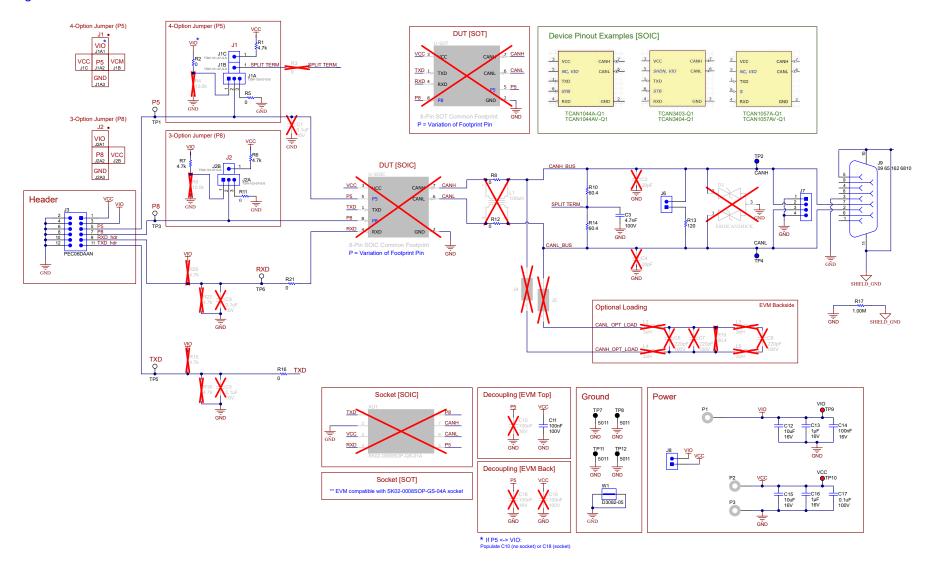


Figure 3-1. EVM Schematic



3.2 PCB Layouts

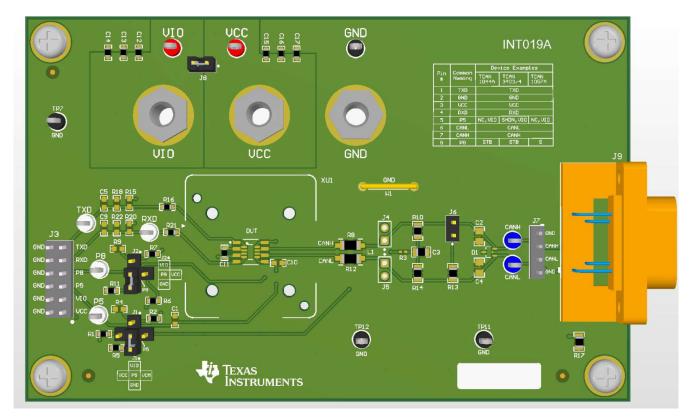


Figure 3-2. EVM Layout (Top View)

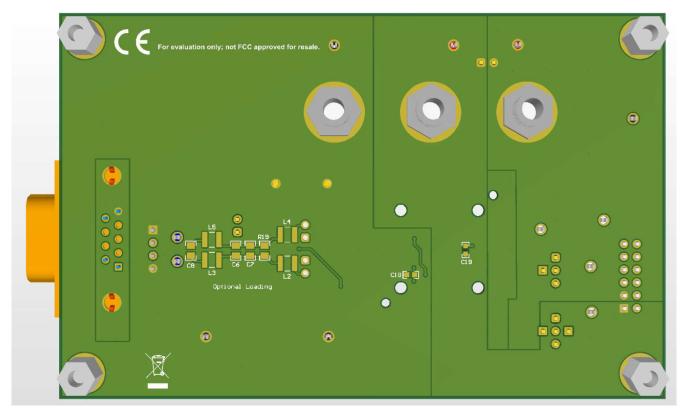


Figure 3-3. EVM Layout (Bottom View)

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3.3 Bill of Materials (BOM)

Table 3-1. Bill of Materials

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
C3	1	4700pF	CAP, CERM, 4700pF, 100V, +/- 10%, X7R, 0805	805	08051C472KAT2A	AVX
C11	1	0.1uF	CAP, CERM, 0.1uF, 100V,+/- 10%, X7R, AEC- Q200 Grade 1, 0603	603	GCJ188R72A104KA01D	MuRata
C12, C15	2	10uF	CAP, CERM, 10uF, 16V, +/- 20%, X5R, 0603	603	GRM188R61C106MAALD	MuRata
C13, C16	2	1uF	CAP, CERM, 1uF, 16V, +/- 10%, X7R, 0603	603	C1608X7R1C105K080AC	TDK
C14	1	0.1uF	CAP, CERM, 0.1μF, 16V,+/- 10%, X7R, AEC- Q200 Grade 1, 0603	603	0603YC104K4T4A	AVX
C17	1	0.1uF	CAP, CERM, 0.1uF, 100V, +/- 10%, X7S, AEC- Q200 Grade 1, 0603	603	CGA3E3X7S2A104K080AB	TDK
FID1, FID2, FID3	3		Fiducial mark. There is nothing to buy or mount.	N/A	N/A	N/A
H1, H2, H3, H4	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw	NY PMS 440 0025 PH	B&F Fastener Supply
H5, H6, H7, H8	4		Standoff, Hex, 0.5"L #4-40 Nylon	Standoff	1902C	Keystone
J1A, J2A	2		Header, 100mil, 3x1, Gold, TH	3x1 Header	TSW-103-07-G-S	Samtec
J1B, J1C, J2B	3		Header, 100mil, 1pos, Gold, TH	Test point	TSW-101-07-G-S	Samtec
J3	1		Header, 100mil, 6x2, Tin, TH	Header, 6x2, 100mil, Tin	PEC06DAAN	Sullins Connector Solutions
J6, J8	2		Header, 100mil, 2x1, Gold, TH	2x1 Header	TSW-102-07-G-S	Samtec
J7	1		Header, 100mil, 4x1, Tin, TH	Header, 4x1, 100mil, TH	PEC04SAAN	Sullins Connector Solutions
J9	1		D-Sub-9, 11Pos, Male, TH	D-Sub-9, 2rows, Male, TH	09 65 162 6810	Harting
LBL1	1		Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650 x 0.200 inch	THT-14-423-10	Brady
P1, P2, P3	3		Standard Banana Jack, Uninsulated, 15A	Banana Jack	108-0740-001	Cinch Connectivity
R1, R6, R7	3	4.7k	RES, 4.7 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	603	CRCW06034K70JNEA	Vishay-Dale
R2, R5, R11, R16, R21	5	0	RES, 0, 0%, 0.25 W, AEC-Q200 Grade 0, 0603	603	PMR03EZPJ000	Rohm

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Table 3-1. Bill of Materials (continued)

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
R8, R12	2	0	RES, 0, 5%, 0.25 W, AEC-Q200 Grade 0, 1206	1206	CRCW12060000Z0EA	Vishay-Dale
R10, R14	2	60.4	RES, 60.4, 1%, 0.125 W, AEC-Q200 Grade 0, 0805	805	CRCW080560R4FKEA	Vishay-Dale
R13	1	120	RES, 120, 5%, 0.5 W, 0805	805	ERJ-P06J121V	Panasonic
R17	1	1.00Meg	RES, 1.00M, 1%, 0.125W, AEC-Q200 Grade 0, 0805	805	ERJ-6ENF1004V	Panasonic
SH-J1, SH-J2, SH-J8	3		Shunt, 2.54mm, Gold, Black	Shunt, 2.54mm, Black	60900213421	Wurth Elektronik
TP1, TP3, TP5, TP6	4		Test Point, Multipurpose, White, TH	White Multipurpose Test point	5012	Keystone Electronics
TP2, TP4	2		Test Point, Multipurpose, Blue, TH	Blue Multipurpose Test point	5127	Keystone Electronics
TP7, TP8, TP11, TP12	4		Test Point, Multipurpose, Black, TH	Black Multipurpose Test point	5011	Keystone Electronics
TP9, TP10	2		Test Point, Multipurpose, Red, TH	Red Multipurpose Test point	5010	Keystone Electronics
W1	1		1mm Uninsulated Shorting Plug, 10.16mm spacing, TH	Shorting Plug, 10.16mm spacing, TH	D3082-05	Harwin
C1, C5, C9, C10, C18	0	0.1uF	CAP, CERM, 0.1uF, 16V, +/- 10%, X7R, AEC- Q200 Grade 1, 0603	603	CGJ3E2X7R1C104K080AA	TDK
C2, C4	0	20pF	CAP, CERM, 20pF, 100V, +/- 5%, C0G/NP0, 0805	805	08051A200JAT2A	AVX
C6, C7, C8	0	220pF	CAP, CERM, 220pF, 100V, +/- 5%, C0G/NP0, 0805	805	C0805C221J1GACTU	Kemet
C19	0	0.1uF	CAP, CERM, 0.1µF, 100V,+/- 10%, X7R, AEC-Q200 Grade 1, 0603	603	HMK107B7104KAHT	Taiyo Yuden
D1	0		24V, 2-Channel ESD Protection Diode for In- Vehicle Networks, SC70-3	SC70-3	ESD2CAN24DCK	Texas Instruments
J4, J5	0		Header, 100mil, 2x1, Gold, TH	2x1 Header	TSW-102-07-G-S	Samtec
L1	0	100uH	Inductor, Ferrite, 100uH, 0.15A, 2 ohm, SMD	SMD, 4-Leads, Body 4.7 x 3.7mm	ACT45B-101-2P-TL003	TDK

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Table 3-1. Bill of Materials (continued)

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
L2, L3, L4, L5	0	3uH	Ind Chip Wirewound 3uH 5% 7.9MHz 20Q- Factor Ceramic 300mA 1210 T/R	1210	AISC-1210-3R0J-T	Abracon
R3	0	0	RES, 0, 5%, 0.063 W, 0402	402	RC0402JR-070RL	Yageo America
R4, R9	0	10.0k	RES, 10.0 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	603	RMCF0603FT10K0	Stackpole Electronics Inc
R15, R18, R20, R22	0	4.7k	RES, 4.7 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	603	CRCW06034K70JNEA	Vishay-Dale
R19	0	60.4	RES, 60.4, 1%, 0.125 W, AEC-Q200 Grade 0, 0805	805	CRCW080560R4FKEA	Vishay-Dale
SH-J3, SH-J4, SH- J5, SH-J6, SH-J7	0		Shunt, 2.54mm, Gold, Black	Shunt, 2.54mm, Black	60900213421	Wurth Elektronik
U-SOIC	0		Fault-Protected CAN FD Transceiver with Signal Improvement Capability (SIC) and Standby Mode	SOIC8		Texas Instruments
U-SOT	0		Automotive High Speed CAN Transceiver	SOT23-8	TCAN1044DDFRQ1	Texas Instruments
XU1	0		Socket, SOIC-8, 1.27mm Pitch	Socket, SOIC-8, 1.27mm Pitch	SK02-0008SOP-QS-01A	RS Tech Incorporated

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4 Additional Information

All TI's 8-pin CAN transceivers supported by this EVM are listed on ti.com: CAN transceivers.

4.1 Trademarks

All trademarks are the property of their respective owners.

STANDARD TERMS FOR EVALUATION MODULES

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 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after the defect has been detected.
 - 2.3 Tl's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. Tl's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by Tl and that are determined by Tl not to conform to such warranty. If Tl elects to repair or replace such EVM, Tl shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGREDATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types lated in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
 - https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above. User will be subject to penalties of Radio Law of Japan.

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- 2. 実験局の免許を取得後ご使用いただく。
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- 3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html
- 3.4 European Union
 - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

- 4 EVM Use Restrictions and Warnings:
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 Safety-Related Warnings and Restrictions:
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
- 5. Accuracy of Information: To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. Disclaimers:

- 6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.
- 6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.
- 7. USER'S INDEMNITY OBLIGATIONS AND REPRESENTATIONS. USER WILL DEFEND, INDEMNIFY AND HOLD TI, ITS LICENSORS AND THEIR REPRESENTATIVES HARMLESS FROM AND AGAINST ANY AND ALL CLAIMS, DAMAGES, LOSSES, EXPENSES, COSTS AND LIABILITIES (COLLECTIVELY, "CLAIMS") ARISING OUT OF OR IN CONNECTION WITH ANY HANDLING OR USE OF THE EVM THAT IS NOT IN ACCORDANCE WITH THESE TERMS. THIS OBLIGATION SHALL APPLY WHETHER CLAIMS ARISE UNDER STATUTE, REGULATION, OR THE LAW OF TORT, CONTRACT OR ANY OTHER LEGAL THEORY, AND EVEN IF THE EVM FAILS TO PERFORM AS DESCRIBED OR EXPECTED.

- 8. Limitations on Damages and Liability:
 - 8.1 General Limitations. IN NO EVENT SHALL TI BE LIABLE FOR ANY SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL, OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF THESE TERMS OR THE USE OF THE EVMS, REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. EXCLUDED DAMAGES INCLUDE, BUT ARE NOT LIMITED TO, COST OF REMOVAL OR REINSTALLATION, ANCILLARY COSTS TO THE PROCUREMENT OF SUBSTITUTE GOODS OR SERVICES, RETESTING, OUTSIDE COMPUTER TIME, LABOR COSTS, LOSS OF GOODWILL, LOSS OF PROFITS, LOSS OF SAVINGS, LOSS OF USE, LOSS OF DATA, OR BUSINESS INTERRUPTION. NO CLAIM, SUIT OR ACTION SHALL BE BROUGHT AGAINST TI MORE THAN TWELVE (12) MONTHS AFTER THE EVENT THAT GAVE RISE TO THE CAUSE OF ACTION HAS OCCURRED.
 - 8.2 Specific Limitations. IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, , EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.
- 9. Return Policy. Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.
- 10. Governing Law: These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

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